2**565935**供应商

Silicon NPN triple diffusion planar type

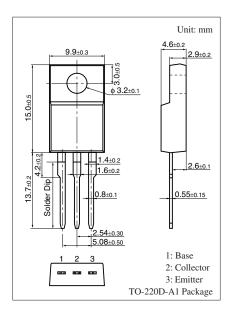
For power amplification For TV vertical deflection output

Features

- Satisfactory linearity of forward current transfer ratio h_{FE}
- Dielectric breakdown voltage of the package: 5 kV
- Full-pack package which can be installed to the heat sink with one screw.

Absolute Maximum Ratings $T_C = 25^{\circ}C$

Parameter	Symbol	Rating	Unit				
Collector-base voltage (Emitter open	V _{CBO}	200	V				
Collector-emitter voltage (Base open) V _{CEO}	180	V				
Emitter-base voltage (Collector open	V _{EBO}	6	V				
Collector current	I _C	2	А				
Peak collector current	I _{CP}	3	А				
Collector power	P _C	25	W				
dissipation $T_a = 25^{\circ}C$		2.0					
Junction temperature	Tj	150	°C				
Storage temperature	T _{stg}	-55 to +150	°C				



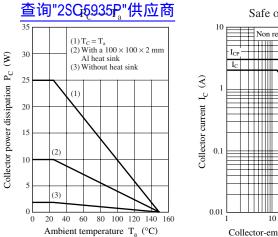
Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 50 \ \mu A, \ I_{\rm E} = 0$	200			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 5 {\rm mA}, I_{\rm B} = 0$	180			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = 500 \ \mu A, \ I_{\rm C} = 0$	6			V
Base-emitter voltage	V _{BE}	$V_{CE} = 10 \text{ V}, I_C = 400 \text{ mA}$			1	V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 200 \text{ V}, I_E = 0$			50	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = 4 V, I_C = 0$			50	μΑ
Forward current transfer ratio	h _{FE1} *	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}$	60		240	_
	h _{FE2}	$V_{CE} = 10 \text{ V}, I_C = 400 \text{ mA}$	50			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$			1	V
Transition frequency	f _T	$V_{CE} = 10 \text{ V}, I_C = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz

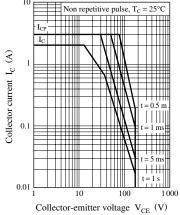
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

Rank	Q	Р
h _{FE1}	60 to 140	100 to 240







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